



60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BVDSS	Rds(ON)	I _D T _C = +25°C (Note 7)
60V	$8m\Omega$ @ $V_{GS} = 10V$	100A
60 V	$12m\Omega$ @ V _{GS} = 4.5V	85A

Description

This new generation n-channel enhancement mode MOSFET is designed to minimize R_{DS(ON)} yet maintain superior switching performance.

Applications

- Notebook battery power managements
- DC-DC converters
- Load switches

Features

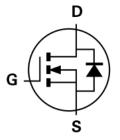
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production -Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An automotive-compliant part is available under separate datasheet (DMTH6010LPSQ)

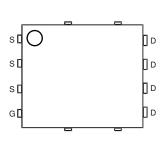
Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)









Internal Schematic

Top View Pin Configuration

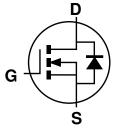
Site 2:

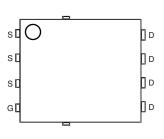
Top View

Top View

PowerDI5060-8/SWP (Type UX)







Bottom View

Internal Schematic

Top View Pin Configuration

Notes:

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

Pin1

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



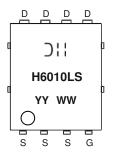
Ordering Information (Note 4)

Part Number	Paakaga	Packing		
Fait Number	Package	Qty.	Carrier	
DMTH6010LPS-13	PowerDI5060-8	2,500	Tape & Reel	
DMTH6010LPS-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note:

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





☐ H=Manufacturer's Marking
H6010LS = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Last Two Digits of Year (ex: 23 = 2023)
WW = Week Code (01 to 53)

$\label{eq:maximum Ratings} \textbf{Maximum Ratings} \ (\textcircled{0}\textbf{T}_{A} = +25\text{°C}, \, \text{unless otherwise specified.})$

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	60	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current (Note 5)	$T_A = +25^{\circ}C$ $T_A = +100^{\circ}C$	lο	13.5 10.4	Α
Continuous Drain Current (Notes 6 & 7)	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	lo	100 75	Α
Maximum Continuous Body Diode Forward Current (Note 6)		Is	100	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	400	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		lsм	400	Α
Avalanche Current, L=0.1mH		las	20	Α
Avalanche Energy, L=0.1mH		Eas	20	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.6	W
Thermal Resistance, Junction to Ambient (Note 5)		Reja	57	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	PD	136	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	1.1	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. Limited by package.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BVDSS	60		_	٧	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 48V, V _{GS} = 0V	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance		_	5.4	8	mΩ	V _{GS} = 10V, I _D = 20A	
Static Drain-Source On-Resistance	RDS(ON)	_	8.3	12	11177	$V_{GS} = 4.5V, I_{D} = 20A$	
Diode Forward Voltage	V _{SD}	_	0.8	1.2	V	V _{GS} = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 9)				•			
Input Capacitance	Ciss	_	2,090	_		V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	746	_	pF		
Reverse Transfer Capacitance	Crss	_	38.5	_			
Gate Resistance	Rg	0.2	0.59	1.5	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (VGS = 4.5V)	Qg	_	19.3	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	41.3	_	~C	V _{DS} = 30V, I _D = 20A	
Gate-Source Charge	Qgs	_	6	_	nC		
Gate-Drain Charge	Qgd	_	8.8	_			
Turn-On Delay Time	t _{D(ON)}	_	5.7	_			
Turn-On Rise Time	tR	_	4.3	_		$V_{DD} = 30V$, $V_{GS} = 10V$, $I_D = 20A$, $R_G = 3\Omega$	
Turn-Off Delay Time	tD(OFF)	_	23.4	_	ns		
Turn-Off Fall Time	tr	_	9.7	_			
Body Diode Reverse Recovery Time	trr	_	35.4	_	ns	1 00A -11/-14 400A/	
Body Diode Reverse Recovery Charge	Q _{RR}	_	38.2	_	nC	I _F = 20A, di/dt = 100A/μs	

Notes:

^{8.} Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.



30.0 V_{GS}=3.5V 25.0 V_{GS}=3.0V V_{GS}=4.0V ID, DRAIN CURRENT (A) V_{GS}=4.5V 20.0 15.0 V_{GS}=10V 10.0 5.0 _{GS}=2.5V $V_{GS}=2.2V$ 0.0 2 3 0 V_{DS}, DRAIN-SOURCE VOLTAGE (V)

Figure 1. Typical Output Characteristic

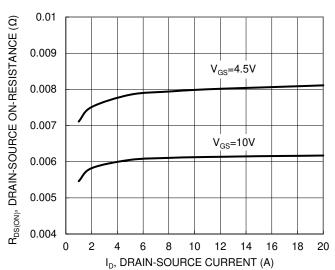


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

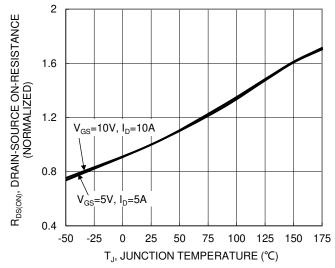


Figure 5. On-Resistance Variation with Temperature

DMTH6010LPS

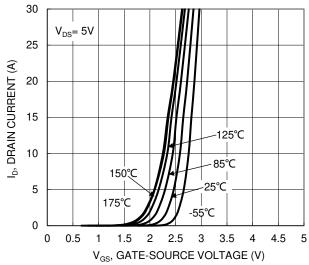


Figure 2. Typical Transfer Characteristic

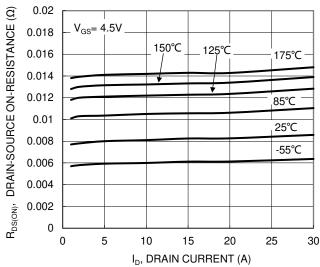


Figure 4. Typical On-Resistance vs. Drain Current and Temperature

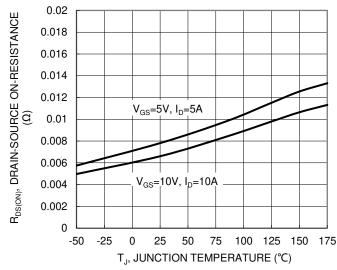


Figure 6. On-Resistance Variation with Temperature





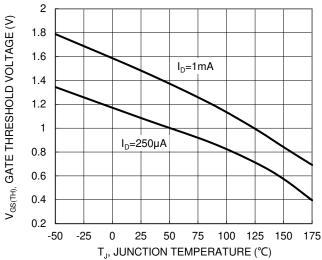


Figure 7. Gate Threshold Variation vs. Junction Temperature

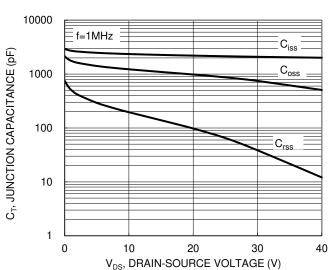
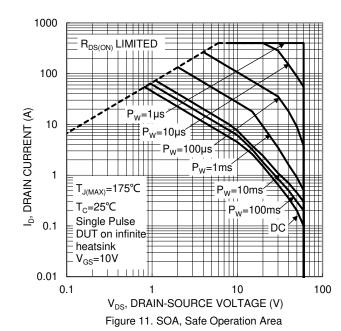


Figure 9. Typical Junction Capacitance



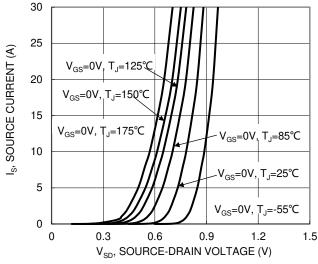
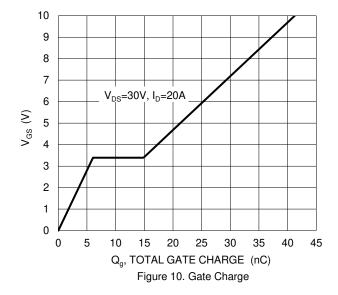


Figure 8. Diode Forward Voltage vs. Current





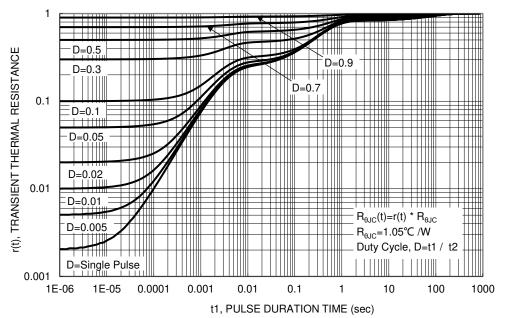


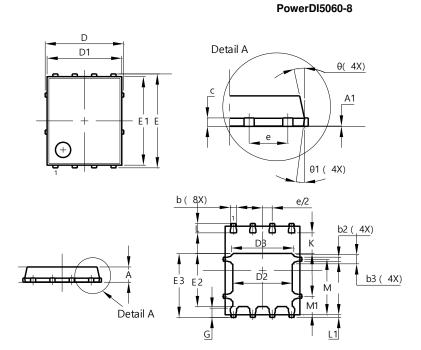
Figure 12. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

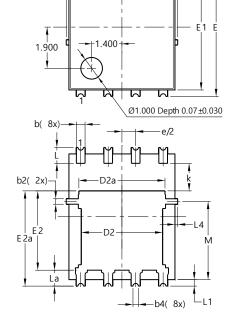
Site 1:



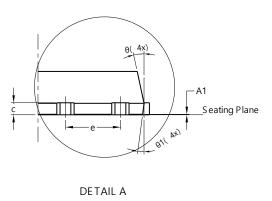
PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A 1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	(6.15 BSC	;		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	•	1.27 BSC			
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

Site 2:

PowerDI5060-8/SWP (Type UX)



-D1



DETAIL A

PowerDI5060-8/SWP				
(Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A 1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	C).25REF	-	
С	0.230	0.330	0.277	
D	5	.15 BS()	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6	.40 BS0	\sim	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1	.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

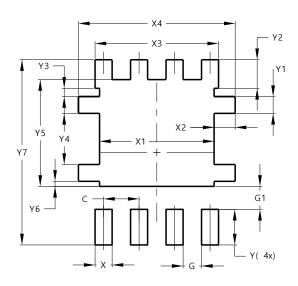


Suggested Pad Layout

 $Please \ see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

Site 1:

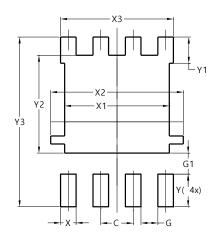
PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y 7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)	
С	1.270	
G	0.660	
G1	0.820	
X	0.610	
X1	4.100	
X2	5.190	
Х3	4.420	
Υ	1.270	
Y1	1.020	
Y2	3.810	
Y3	6.610	



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